1

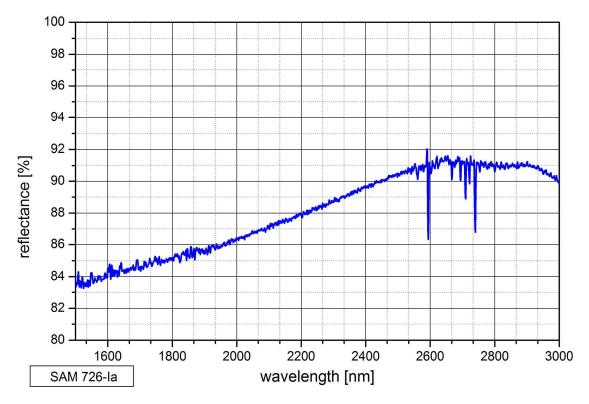


SAM™ Data Sheet SAM-2900-9-10ps-x, λ = 2900 nm

Laser wavelength	λ = 2900 nm
High reflection band	λ = 2400 3000 nm
Absorbance	A ₀ = 9 %
Modulation depth	$\Delta R = 4 \%$
Non-saturable loss	A _{ns} = 5 %
Saturation fluence	Φ_{sat} = 150 µJ/cm ²
Relaxation time constant	τ ~ 10 ps
Damage threshold	$\Phi_{sat} = 2 \text{ mJ/cm}^2$
Chip area	4.0 mm x 4.0 mm; other dimensions on request
Chip thickness	620 μm
Reverse design	the absorber layer is illuminated through the 620 μm thick GaAs wafer
Mounting option x denotes the type of mounting as follows: $\mathbf{x} = 0$ unmounted $\mathbf{x} = 12.7 \text{ g}$ dued on a copper heat sink with 12.7 mm diameter	

x = 12.7 g	glued on a copper heat sink with 12.7 mm diameter
x = 25.4 g	glued on a copper heat sink with 25.4 mm diameter

Low intensity spectral reflectance





Reverse design of the SAM-2900-9-x-10ps

